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Application No.: 10/757,735 Filed: January 14, 2004 Inventor(s):

Garnett, et al.

Title:

INTEGRAL HEATSINK

GROUNDING ARRANGEMENT

Examiner: Levi, Dameon E. Group/Art Unit: 2841 Atty. Dkt. No: 5681-78000 Confirmation No.: 4872 8888888888 I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date indicated below. B. Noël Kivlin Registered Representative June 21, 2006 Signature

AMENDMENT; RESPONSE TO OFFICE ACTION MAILED MARCH 21, 2006

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Please amend the above-captioned application as follows.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims that begins on page 3 of this paper.

Remarks begin on page 9 of this paper.